

### Features

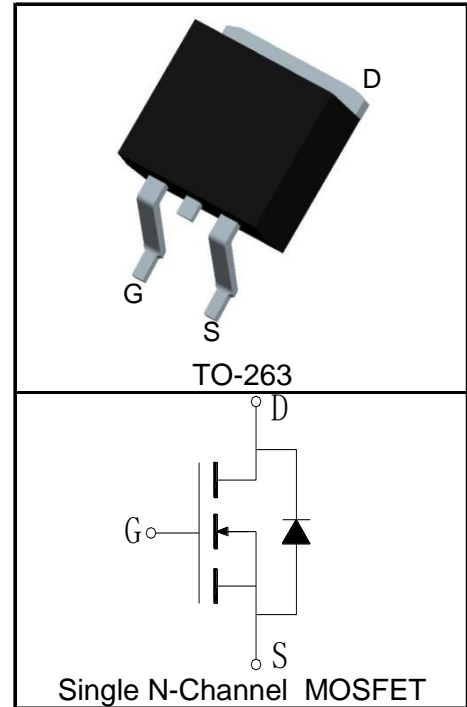
- 100V/125A,  
 $R_{DS(ON)} = 4.5m\Omega(Typ.)@V_{GS}=10V$   
 $R_{DS(ON)} = 5.5m\Omega(Typ.)@V_{GS}=4.5V$
- Excellent  $Q_G \times R_{DS(on)}$  product(FOM)
- SGT Technology
- 100% Avalanche Tested

### Applications

- High Frequency Switching and Synchronous Rectification



### Pin Description



### Absolute Maximum Ratings

| Symbol   | Parameter                                | Rating            | Unit         |   |
|--|--|-------------------|--------------|---|
| <b>Common Ratings</b> ( $T_C=25^\circ C$ Unless Otherwise Noted) |  |                   |              |   |
| $V_{DSS}$  | Drain-Source Voltage                     | 100               | V            |   |
| $V_{GSS}$  | Gate-Source Voltage                      | $\pm 20$          |              |   |
| $T_J$  | Maximum Junction Temperature             | 175               | $^\circ C$   |   |
| $T_{STG}$  | Storage Temperature Range                | -55 to 175        | $^\circ C$   |   |
| $I_S$  | Diode Continuous Forward Current         | $T_C=25^\circ C$  | 125          | A |
| <b>Mounted on Large Heat Sink</b>                                |  |                   |              |   |
| $I_{DP}^{(1)}$   | 300 $\mu s$ Pulse Drain Current Tested   | $T_C=25^\circ C$  | 500          | A |
| $I_D^{(2)}$  | Continuous Drain Current( $V_{GS}=10V$ ) | $T_C=25^\circ C$  | 125          | A |
|  |  | $T_C=100^\circ C$ | 88           |   |
| $P_D$  | Maximum Power Dissipation                | $T_C=25^\circ C$  | 158          | W |
|  |  | $T_C=100^\circ C$ | 79           |   |
| $R_{\theta JC}$  | Thermal Resistance-Junction to Case      | 0.95              | $^\circ C/W$ |   |
| $R_{\theta JA}^{(3)}$  | Thermal Resistance-Junction to Ambient   | 62.5              | $^\circ C/W$ |   |
| <b>Drain-Source Avalanche Ratings</b>                            |  |                   |              |   |
| $E_{AS}^{(4)}$   | Avalanche Energy, Single Pulsed          | 256               | mJ           |   |

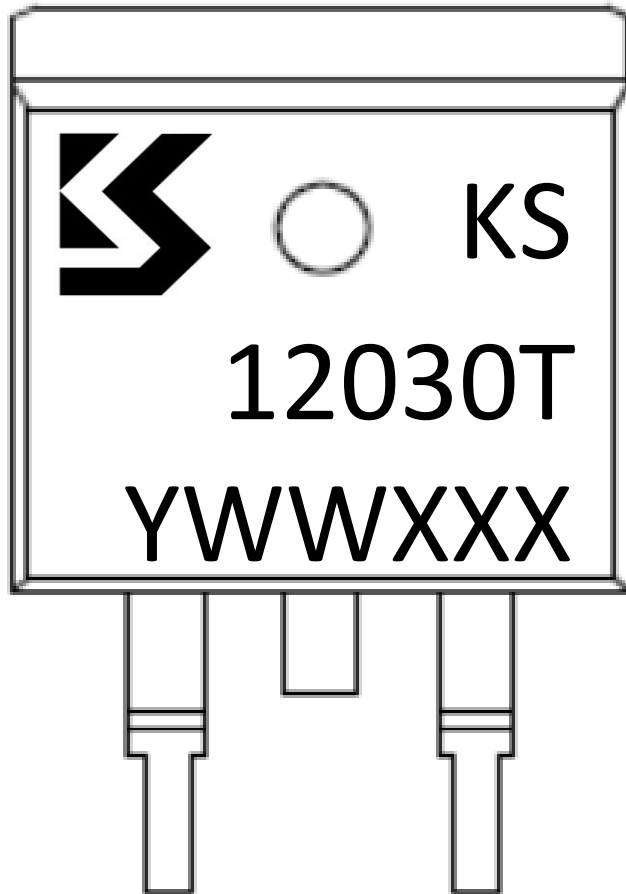
**Electrical Characteristics** ( $T_C=25^\circ\text{C}$  Unless Otherwise Noted)

| Symbol   | Parameter                        | Test Condition  | KS12030GAT |      |           | Unit      |
|--|----------------------------------|---|------------|------|-----------|-----------|
|  |                                  |   | Min.       | Typ. | Max.      |           |
| <b>Static Characteristics</b>                    |                                  |   |            |      |           |           |
| $BV_{DSS}$                                       | Drain-Source Breakdown Voltage   | $V_{GS}=0V, I_{DS}=250\mu A$                            | 100        |      |           | V         |
| $I_{DSS}$  | Zero Gate Voltage Drain Current  | $V_{DS}=100V, V_{GS}=0V$                                |            |      | 1         | $\mu A$   |
|  |                                  | $T_J=125^\circ C$                                       |            |      | 30        |           |
| $V_{GS(th)}$                                     | Gate Threshold Voltage           | $V_{DS}=V_{GS}, I_{DS}=250\mu A$                        | 1.1        | 1.8  | 2.3       | V         |
| $I_{GSS}$  | Gate Leakage Current             | $V_{GS}=\pm 20V, V_{DS}=0V$                             |            |      | $\pm 100$ | nA        |
| $R_{DS(ON)}^{(5)}$                               | Drain-Source On-state Resistance | $V_{GS}=10V, I_{DS}=20A$                                |            | 4.5  | 6         | $m\Omega$ |
|  |                                  | $V_{GS}=4.5V, I_{DS}=16A$                               |            | 5.5  | 9         | $m\Omega$ |
| <b>Diode Characteristics</b>                     |                                  |   |            |      |           |           |
| $V_{SD}^{(5)}$                                   | Diode Forward Voltage            | $I_{SD}=20A, V_{GS}=0V$                                 |            | 0.84 | 1.2       | V         |
| $t_{rr}$   | Reverse Recovery Time            | $I_{SD}=20A, dI_{SD}/dt=100A/\mu s$                     |            | 27   |           | ns        |
| $Q_{rr}$   | Reverse Recovery Charge          |   |            | 38   |           | nC        |
| <b>Dynamic Characteristics<sup>(6)</sup></b>     |                                  |   |            |      |           |           |
| $R_G$  | Gate Resistance                  | $V_{GS}=0V, V_{DS}=0V, F=1MHz$                          |            | 1.3  |           | $\Omega$  |
| $C_{iss}$  | Input Capacitance                | $V_{GS}=0V,$<br>$V_{DS}=50V,$<br>Frequency=1.0MHz       |            | 3015 |           | pF        |
| $C_{oss}$  | Output Capacitance               |   |            | 1250 |           |           |
| $C_{rss}$  | Reverse Transfer Capacitance     |   |            | 45   |           |           |
| $t_{d(ON)}$                                      | Turn-on Delay Time               | $V_{DD}=50V, I_{DS}=20A,$<br>$V_{GEN}=10V, R_G=3\Omega$ |            | 11   |           | ns        |
| $t_r$  | Turn-on Rise Time                |   |            | 19   |           |           |
| $t_{d(OFF)}$                                     | Turn-off Delay Time              |   |            | 33   |           |           |
| $t_f$  | Turn-off Fall Time               |   |            | 15   |           |           |
| <b>Gate Charge Characteristics<sup>(6)</sup></b> |                                  |   |            |      |           |           |
| $Q_g$  | Total Gate Charge                | $V_{DS}=50V, V_{GS}=10V,$<br>$I_{DS}=20A$               |            | 39   |           | nC        |
| $Q_{gs}$   | Gate-Source Charge               |   |            | 6    |           |           |
| $Q_{gd}$   | Gate-Drain Charge                |   |            | 9    |           |           |

- Notes:
- ① Pulse width limited by safe operating area.
  - ② Calculated continuous current based on maximum allowable junction temperature. The package limitation current is 75A.
  - ③ When mounted on 1 inch square copper board,  $t \leq 10\text{sec}$ . The value in any given application depends on the user's specific board design.
  - ④ Limited by  $T_{Jmax}$ ,  $I_{AS} = 32A$ ,  $L = 0.5mH$ ,  $V_{DD} = 48V$ ,  $R_G = 25\Omega$ , Starting  $T_J = 25^\circ C$ .
  - ⑤ Pulse test; Pulse width  $\leq 300\mu s$ , duty cycle  $\leq 2\%$ .
  - ⑥ Guaranteed by design, not subject to production testing.

**Ordering and Marking Information**

| Device     | Package | Packaging | Quantity | Reel Size | Tape width |
|------------|---------|-----------|----------|-----------|------------|
| KS12030GAT | TO-263  | Tape&Reel | 800      | 13"       | 24mm       |

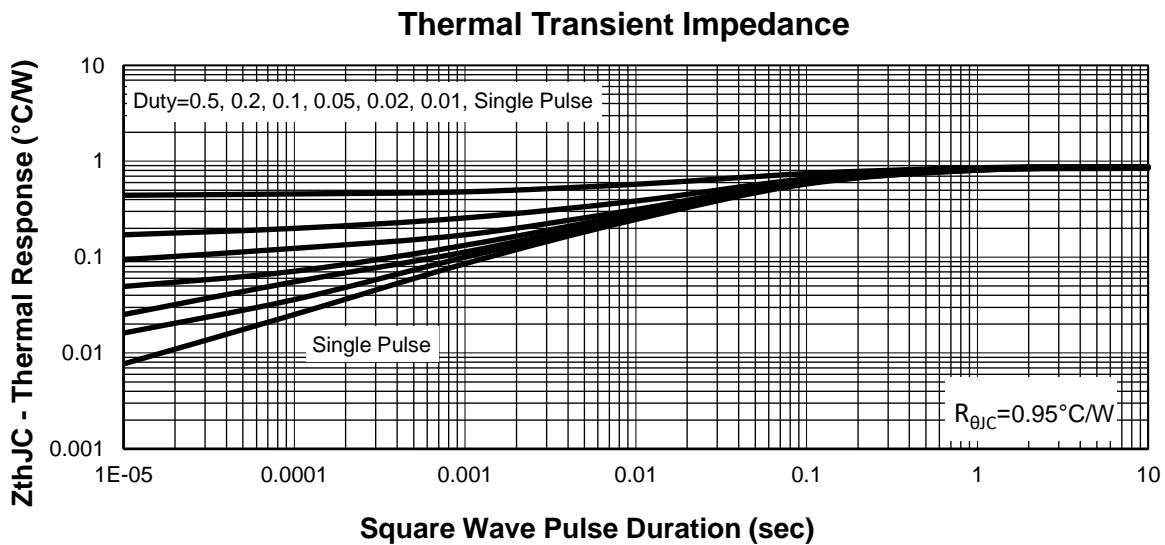
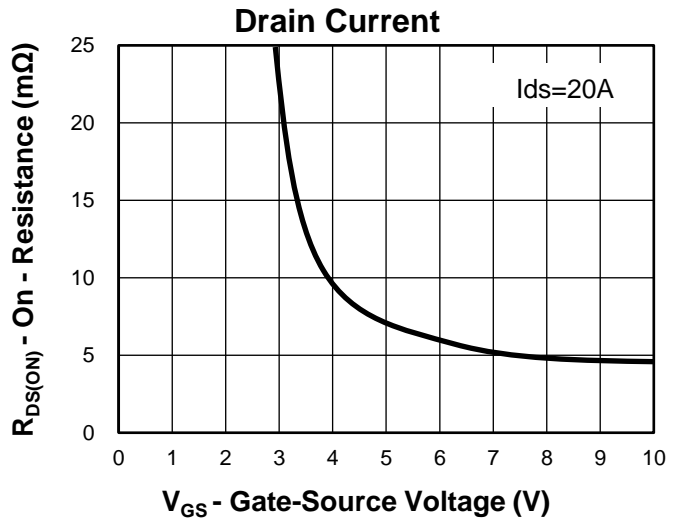
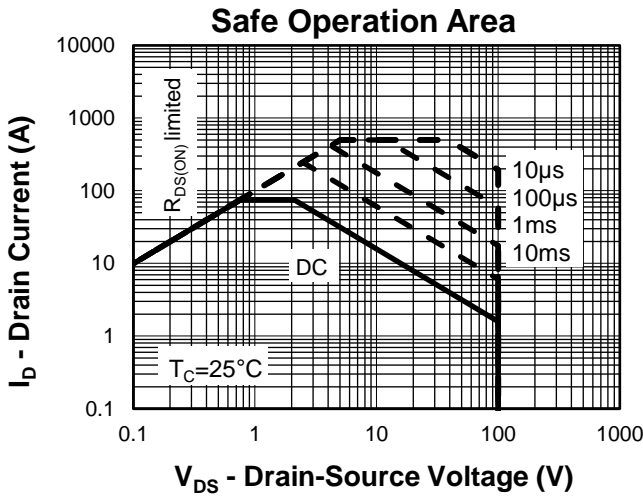
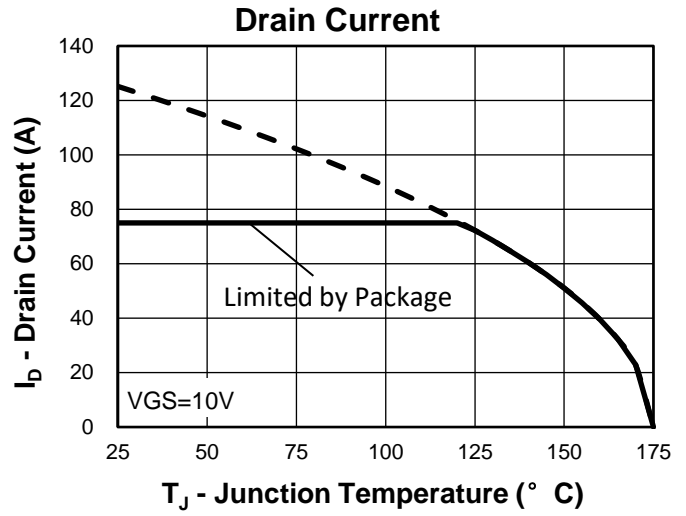
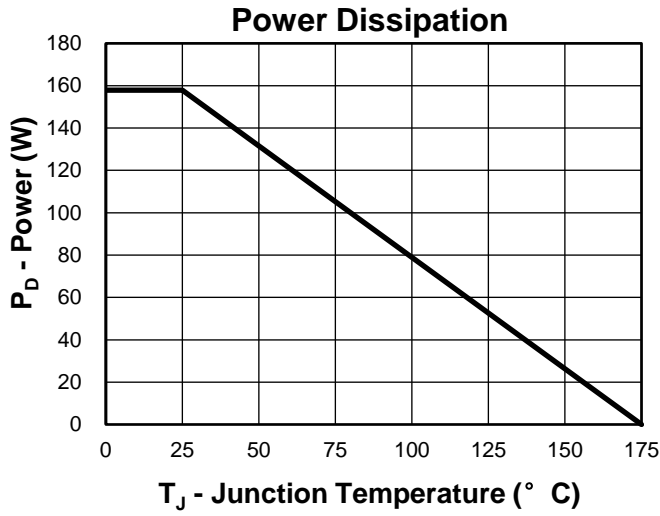


1st Line: Kwansemi LOGO, Kwansemi Code(KS)

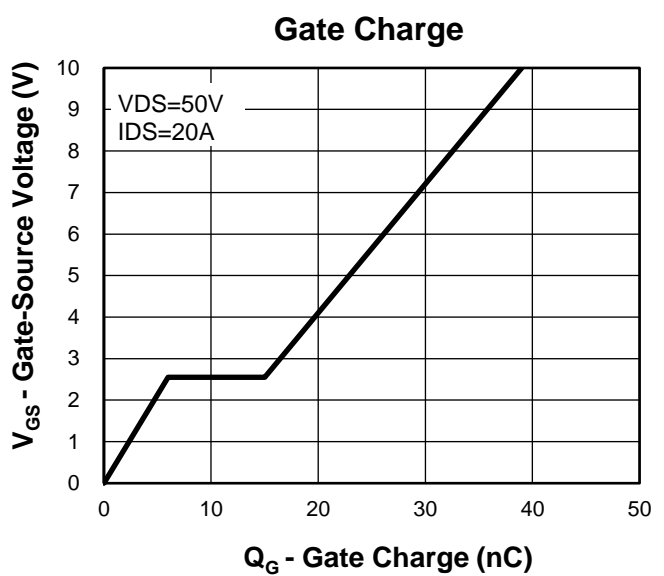
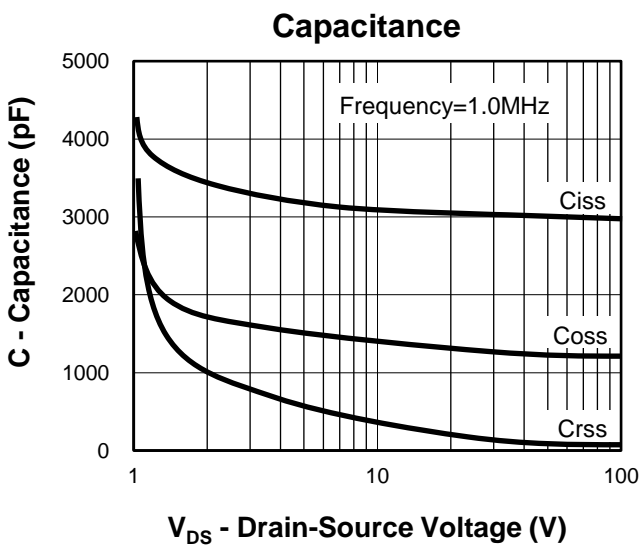
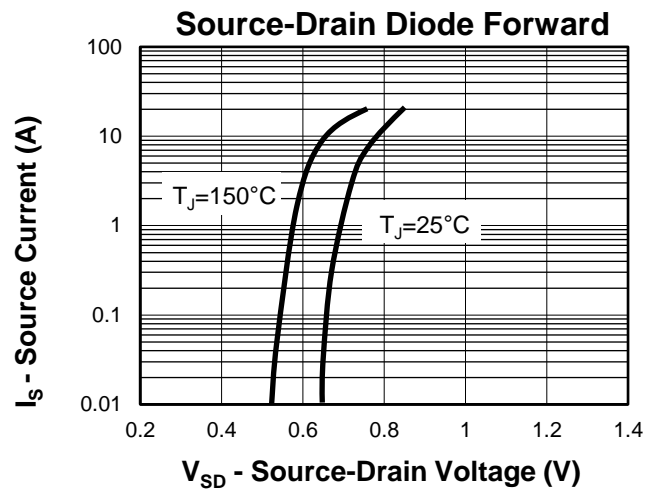
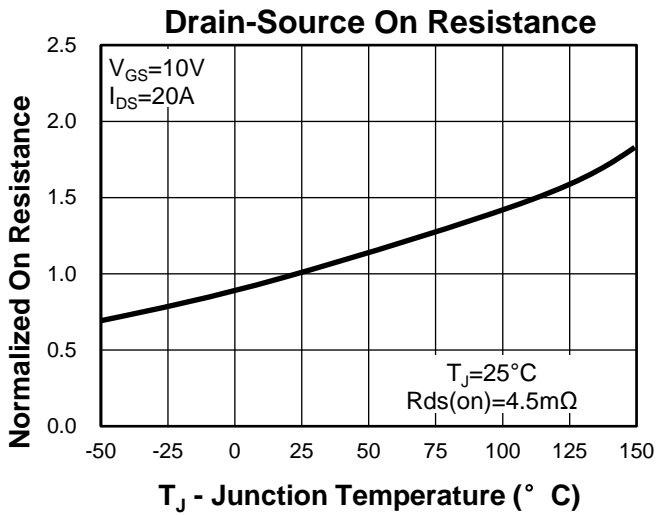
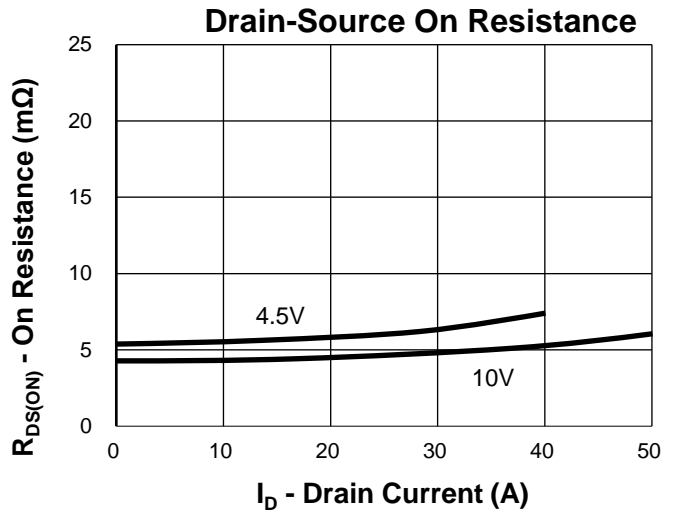
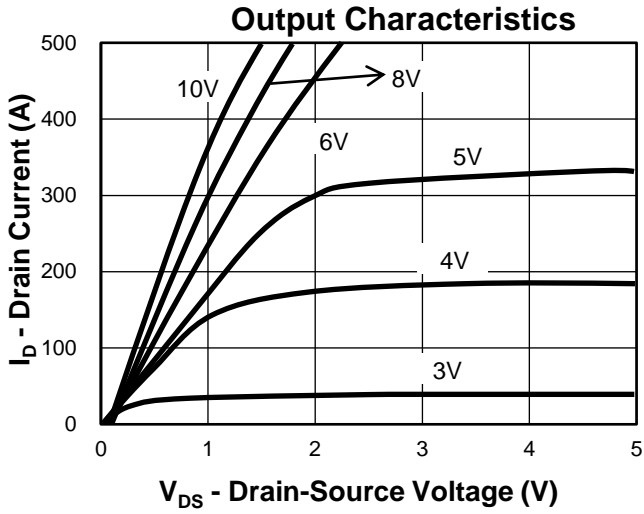
2nd Line: Part Number(12030T)

3rd Line: Lot Number(YWWXXX)

Typical Characteristics



Typical Characteristics





### Avalanche Test Circuit and Waveforms



### Switching Time Test Circuit and Waveforms



### Diode Recovery Test Circuit and Waveforms



### Gate Charge Test Circuit and Waveform



### Customer Service

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